August 2000

National Semiconductor

LP339 Ultra-Low Power Quad Comparator

General Description

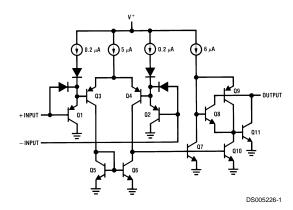
The LP339 consists of four independent voltage comparators designed specifically to operate from a single power supply and draw typically 60 μ A of power supply drain current over a wide range of power supply voltages. Operation from split supplies is also possible and the ultra-low power supply drain current is independent of the power supply voltage. These comparators also feature a common-mode range which includes ground, even when operated from a single supply.

Applications include limit comparators, simple analog-to-digital converters, pulse, square and time delay generators; VCO's; multivibrators; high voltage logic gates. The LP339 was specifically designed to interface with the CMOS logic family. The ultra-low supply current makes the LP339 valuable in battery powered applications.

Advantages

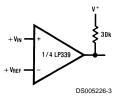
 Ultra-low power supply drain suitable for battery applications

Schematic and Connection Diagrams



Typical Applications (V⁺= 5.0 V_{DC})

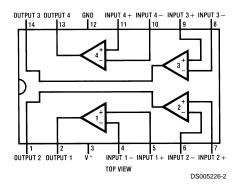




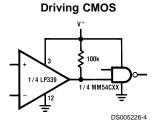
- Single supply operation
- Sensing at ground
- Compatible with CMOS logic family
- Pin-out identical to LM339

Features

- Ultra-low power supply current drain (60 µA)—independent of the supply voltage (75 µW/comparator at +5 V_{DC})
- Low input biasing current: 3 nA
- Low input offset current: ±0.5 nA
- Low input offset voltage: ±2 mV
- Input common-mode voltage includes ground
- Output voltage compatible with MOS and CMOS logic
- High output sink current capability (30 mA at $V_0=2 V_{DC}$)
- Supply Input protected against reverse voltages



Order Number LP339M for S.O. Package See NS Package Number M14A Order Number LP339N for Dual-In-Line Package See NS Package Number N14A



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	36 $V_{\rm DC}$ or ±18 $V_{\rm DC}$
Differential Input Voltage	$\pm 36 V_{DC}$
Input Voltage	–0.3 $V_{\rm DC}$ to 36 $V_{\rm DC}$
Power Dissipation (Note 2)	
Molded DIP	570 mW
Output Short Circuit to GND (Note 3)	Continuous
Input Current V_{IN} <-0.3 V_{DC} (Note 4)	50 mA

Operating Temperature Range	0°C to +70°C			
Storage Temperature Range	-65° to +150°C			
Soldering Information:	00 10 1100 0			
Dual-In-Line Package (10 sec.)	+260°C			
S.O. Package:	1200 0			
Vapor Phase (60 sec.)	+215°C			
Infrared (15 sec.)	+220°C			
See AN-450 "Surface Mounting Methods and Their Effect on				

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Electrical Characteristics

(V+=5 V_{DC}) (Note 5)

Parameter	Conditions	Min	Тур	Max	Units
Input Offset Voltage	T _A =25°C (Note 10)		±2	±5	mV _{DC}
Input Bias Current	$I_{IN}(+)$ or $I_{IN}(-)$ with the		2.5	25	nA _{DC}
	Output in the Linear Range, T _A =25°C (Note 6)				
Input Offset Current $I_{IN}(+)-I_{IN}(-), T_A=25^{\circ}C$			±0.5	±5	nA _{DC}
Input Common T _A =25°C (Note 7)		0		V+-1.5	V _{DC}
Mode Voltage Range					
Supply Current	R _L =Infinite on all Comparators, T _A =25°C		60	100	μA _{DC}
Voltage Gain	$V_{O} = 1 V_{DC}$ to 11 V_{DC} ,		500		V/mV
	R _L =15 kΩ, V ⁺ =15 V _{DC} , T _A =25°C				
Large Signal	V _{IN} =TTL Logic Swing, V _{REF} =1.4 V _{DC} ,		1.3		µSec
Response Time	V_{RL} =5 V_{DC} , R_{L} =5.1 k Ω , T_{A} =25°C				
Response Time	V _{RL} =5 V _{DC} , R _L =5.1 kΩ, T _A =25°C (Note 8)		8		µSec
Output Sink Current	$V_{IN}(-)=1 V_{DC}, V_{IN}(+)=0, V_{O}=2 V_{DC},$	15	30		mA _{DC}
	T _A =25°C (Note 12)				
	V _O =0.4 V _{DC}	0.20	0.70		mA _{DC}
Output Leakage Current	V _{IN} (+)=1 V _{DC} , V _{IN} (-)=0, V _O =5 V _{DC} , T _A =25°C		0.1		nA _{DC}
Input Offset Voltage	(Note 10)			±9	mV _{DC}
Input Offset Current	$I_{IN}(+)-I_{IN}(-)$		±1	±15	nA _{DC}
Input Bias Current	I _{IN} (+) or I _{IN} (–) with Output in Linear Range		4	40	nA _{DC}
Input Common	Single Supply	0		V+-2.0	V _{DC}
Mode Voltage Range					
Output Sink Current	$V_{IN}(-)=1 V_{DC}, V_{IN}(+)=0, V_{O}=2 V_{DC}$	10			mA _{DC}
Output Leakage Current	$V_{IN}(+)=1 V_{DC}, V_{IN}(-)=0, V_{O}=30 V_{DC}$			1.0	μA _{DC}
Differential Input Voltage	All $V_{IN's} \ge 0$ V_{DC} (or V^- on split supplies) (Note 9)			36	V _{DC}

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

Note 2: For elevated temperature operation, T_j max is 125°C for the LP339. θ_{ja} (junction to ambient) is 175°C/W for the LP339N and 120°C/W for the LP339M when either device is soldered in a printed circuit board in a still air environment. The low bias dissipation and the "ON-OFF" characteristic of the outputs keeps the chip dissipation very small ($P_D \le 100$ mW), provided the output transistors are allowed to saturate.

Note 3: Short circuits from the output to V⁺ can cause excessive heating and eventual destruction. The maximum output current is approximately 50 mA.

Note 4: This input current will only exist when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistors becoming forward biased and thereby acting as input clamp diodes. In addition to this diode action, there is also lateral NPN parasitic transistor action on the IC chip. This transistor action can cause the output voltage of the comparators to go to the V+ voltage level (or to ground for a large input overdrive) for the time duration that an input is driven negative. This is not destructive and normal output states will re-establish when the input voltage, which is negative, again returns to a value greater than $-0.3 V_{DC}$ (T_A=25°C).

Note 5: These specifications apply for $V^+=5V_{DC}$ and $0^{\circ}C \le T_A \le 70^{\circ}$ C, unless otherwise stated. The temperature extremes are guaranteed but not 100% production tested. These parameters are not used to calculate outgoing AQL.

Note 6: The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output, so no loading change exists on the reference or the input lines as long as the common-mode range is not exceeded.

Note 7: The input common-mode voltage or either input voltage should not be allowed to go negative by more than 0.3V. The upper end of the common-mode voltage range is V^+ -1.5V (T_A=25°C), but either or both inputs can go to 30 V_{DC} without damage.

Note 8: The response time specified is for a 100 mV input step with 5 mV overdrive. For larger overdrive signals 1.3 µs can be obtained. See Typical Performance Characteristics section.

Electrical Characteristics (Continued)

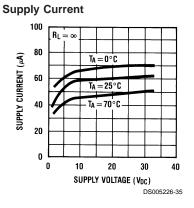
Note 9: Positive excursions of input voltage may exceed the power supply level. As long as the other voltage remains within the common-mode range, the comparator will provide a proper output state. The low input voltage state must not be less than $-0.3 V_{DC}$ (or $0.3 V_{DC}$ below the magnitude of the negative power supply, if used) at T_A=25°C.

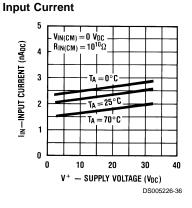
Note 10: At output switch point, V_{O} =1.4V, R_{S} =0 Ω with V⁺ from 5 V_{DC} ; and over the full input common-mode range (0 V_{DC} to V⁺-1.5 V_{DC}).

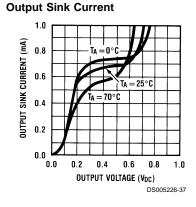
Note 11: For input signals that exceed V^+ , only the overdriven comparator is affected. With a 5V supply, V_{IN} should be limited to 25V maximum, and a limiting resistor should be used on all inputs that might exceed the positive supply.

Note 12: The output sink current is a function of the output voltage. The LP339 has a bi-modal output section which allows it to sink large currents via a Darlington connection at output voltages greater than approximately 1.5 V_{DC} and sink lower currents below this point. (See typical characteristics section and applications section).

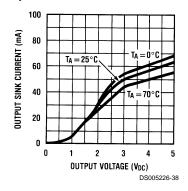
Typical Performance Characteristics



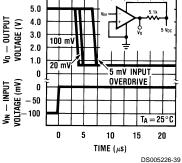




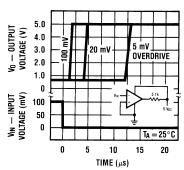
Output Sink Current



Response Times for Various Input Overdrives — Negative Transition



Response Times for Various Input Overdrives — Positive Transition



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Application Hints

All pins of any unused comparators should be tied to the negative supply.

The bias network of the LP339 establishes a drain current which is independent of the magnitude of the power supply voltage over the range of from 2 $V_{\rm DC}$ to 30 $V_{\rm DC}.$

It is usually unnecessary to use a bypass capacitor across the power supply line.

The differential input voltage may be larger than V+ without damaging the device. Protection should be provided to prevent the input voltages from going negative more than -0.3 V_{DC} (at 25°C). An input clamp diode can be used as shown in the application section.

The output section of the LP339 has two distinct modes of operation-a Darlington mode and a grounded emitter mode. This unique drive circuit permits the LP339 to sink 30 mA at V_O=2 V_{DC} (Darlington mode) and 700 μ A at V_O=0.4 V_{DC} (grounded emitter mode). *Figure 1* is a simplified schematic diagram of the LP339 output section.

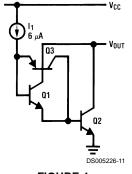
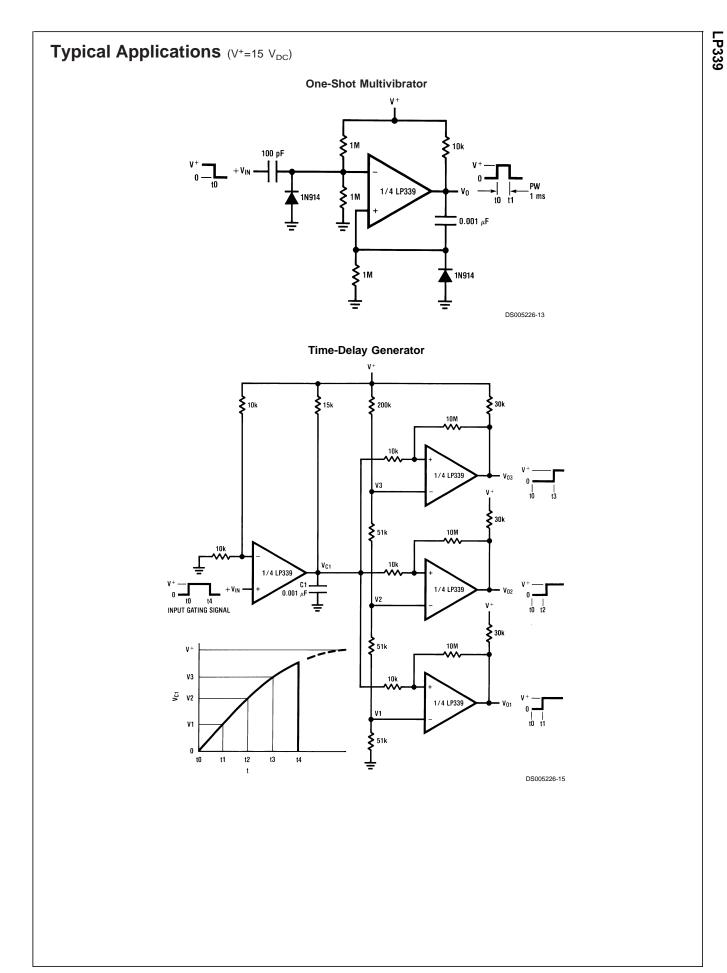


FIGURE 1.

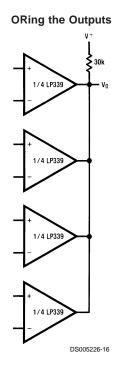
Notice that the output section is configured in a Darlington connection (ignoring Q3). Therefore, if the output voltage is held high enough ($V_O \ge 1 \ V_{DC}$), Q1 is not saturated and the output current is limited only by the product of the betas of Q1, Q2 and I1 (and the $60\Omega \ R_{SAT}$ of Q2). The LP339 is thus capable of driving LED's, relays, etc. in this mode while maintaining an ultra-low power supply current of typically 60 μ A.

If transistor Q3 were omitted, and the output voltage allowed to drop below about 0.8 V_{DC}, transistor Q1 would saturate and the output current would drop to zero. The circuit would, therefore, be unable to "pull" low current loads down to ground (or the negative supply, if used). Transistor Q3 has been included to bypass transistor Q1 under these conditions and apply the current I1 directly to the base of Q2. The output sink current is now approximately I1 times the beta of Q2 (700 μ A at V_O=0.4 V_{DC}). The output of the LP339 exhibits a bi-modal characteristic with a smooth transition between modes. (See Output Sink Current graphs in Typical Performance Characteristics section.)

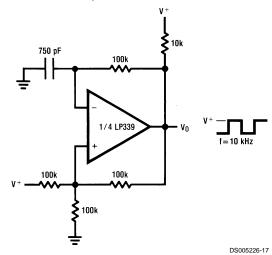
It is also important to note that in both cases the output is an uncommitted collector. Therefore, many collectors can be tied together to provide an output OR'ing function. An output pull-up resistor can be connected to any available power supply voltage within the permitted power supply voltage range and there is no restriction on this voltage due to the magnitude of the voltage which is applied to the V+ terminal of the LP339 package.



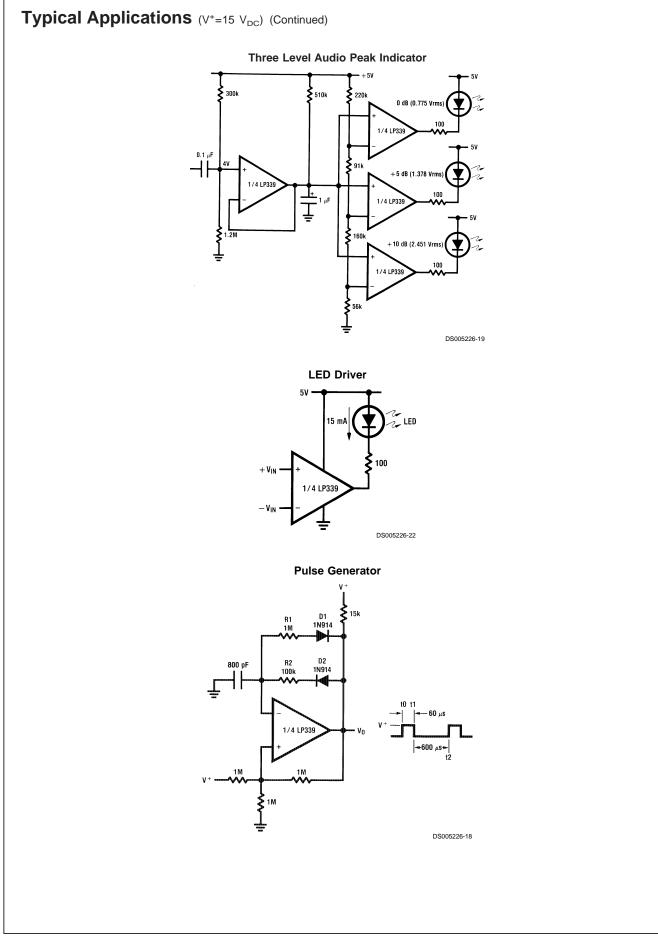
Typical Applications (V⁺=15 V_{DC}) (Continued)



Squarewave Oscillator



LP339

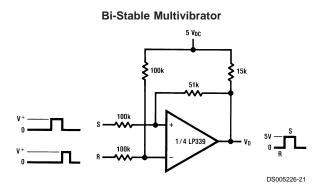


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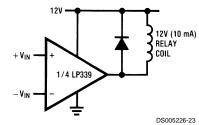
LP339

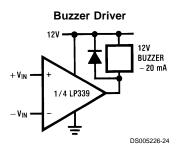
LP339

Typical Applications (V⁺=15 V_{DC}) (Continued)

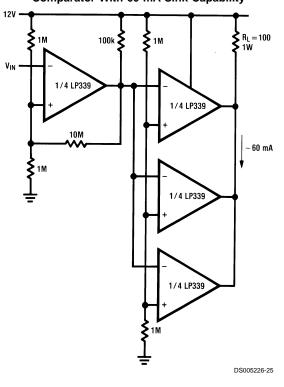




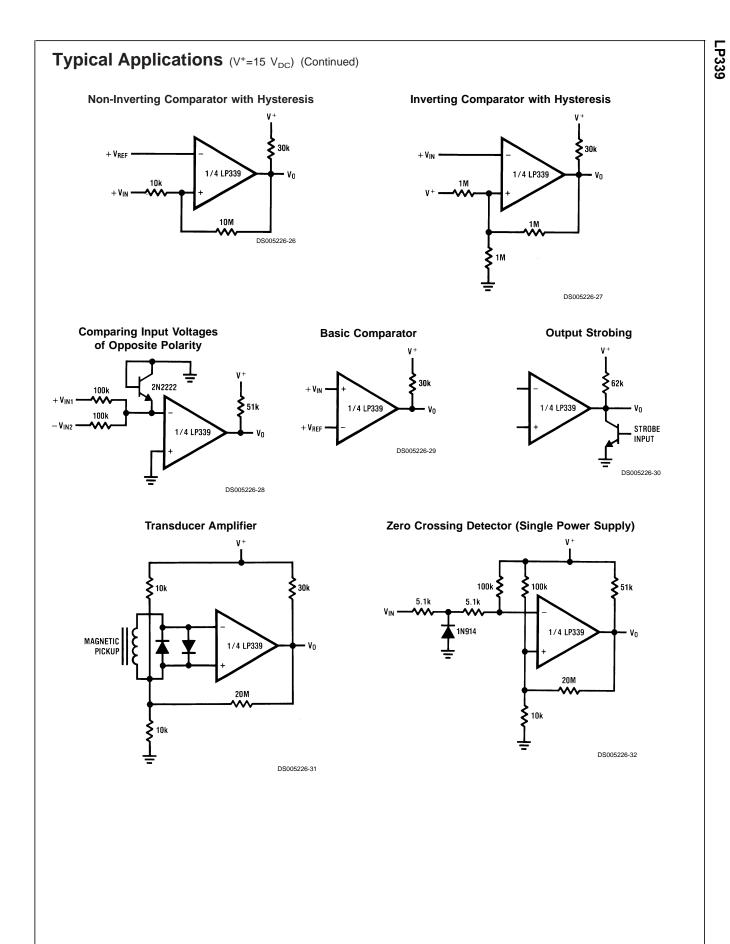




Comparator With 60 mA Sink Capability

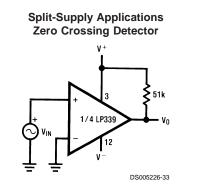


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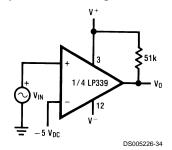


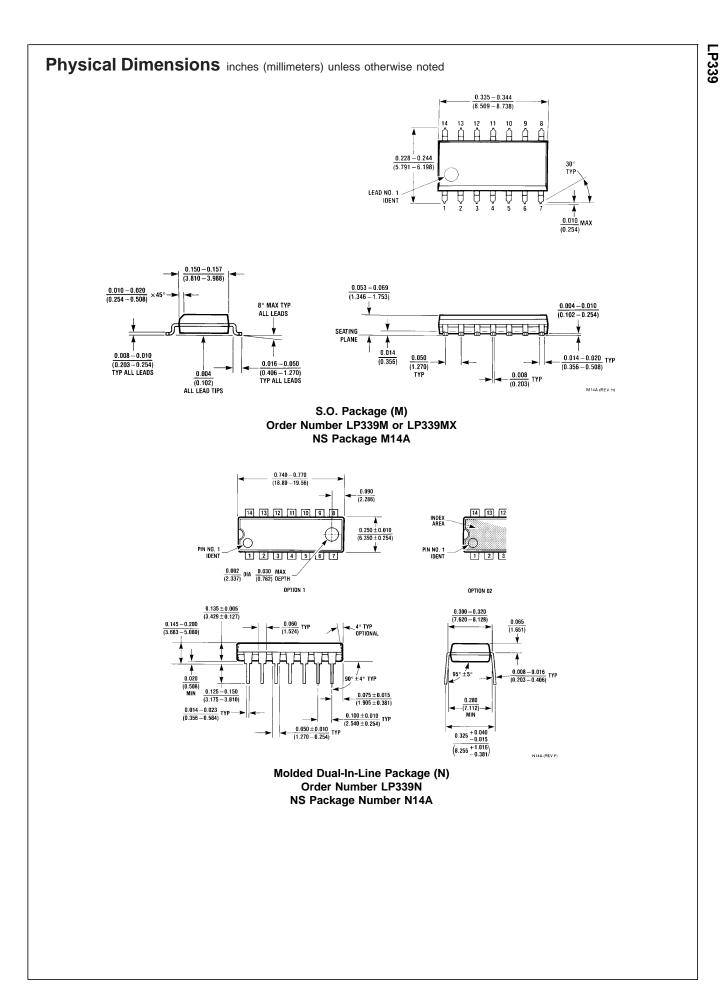
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Typical Applications (V⁺=15 V_{DC}) (Continued)



Comparator With a Negative Reference





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